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<u>Fairchild Semiconductor</u> <u>SI9936DY</u>

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June 1999

Si9936DY*

Dual N-Channel Enhancement Mode MOSFET

General Description

These N-Channel Enhancement Mode MOSFETs are produced using Fairchild Semiconductor's advance process that has been especially tailored to minimize on-state resistance and yet maintain superior switching performance.

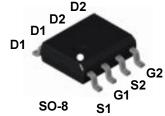
These devices are well suited for low voltage and battery powered applications where low in-line power loss and fast switching are required.

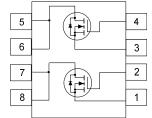
Applications

- · Battery switch
- Load switch
- Motor controls

Features

- 5.0 A, 30 V. $R_{DS(ON)}$ = 0.050 Ω @ V_{GS} = 10 V $R_{DS(ON)}$ = 0.080 Ω @ V_{GS} = 4.5 V
- · Low gate charge.
- Fast switching speed.
- · High power and current handling capability.





Absolute Maximum Ratings T_A = 25°C unless otherwise noted

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Symbol	nbol Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		30	V
V _{GSS}	Gate-Source Voltage		<u>+</u> 20	V
I _D	Drain Current - Continuous	(Note 1a)	5.0	А
	- Pulsed		40	
P _D	Power Dissipation for Single Operation		2.0	W
	Power Dissipation for Single Operation	(Note 1a)	1.6	
		(Note 1b)	1	
		(Note 1c)	0.9	
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C

Thermal Characteristics

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R _{eJA}	Thermal Resistance, Junction-to-Ambient	62.5	∘C/W		
Roic	Thermal Resistance, Junction-to-Case (Note 1)	40	∘C/W		

Package Outlines and Ordering Information

* Die and manufacturing source subject to change without prior notification.

Device Marking	Device	Reel Size	Tape Width	Quantity
9936	SI9936DY	13"	12mm	2500 units
	Опоссовт	10	12	2000

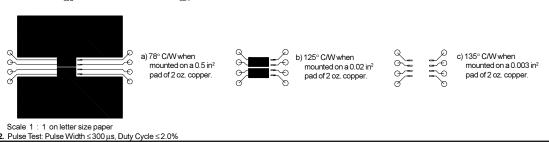
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Electrical Characteristics T_A = 25°C unless otherwise noted **Parameter** Min Units **Symbol Test Conditions** Typ Max Off Characteristics Drain-Source Breakdown $V_{GS} = 0 \text{ V}, I_{D} = 250 \text{ µA}$ 30 ٧ BV_{DSS} Voltage ∧BVoss Breakdown Voltage I_D = 250 _{II}A Referenced to 25°C 70 mV/∘C Temperature Coefficient ΛT_J I_{DSS} Zero Gate Voltage Drain V_{DS} = 24 V, V_{GS} = 0 V 2 μΑ V_{DS} = 24 V, V_{GS} = 0 V, T_J = 55°C 20 Current Gate-Body Leakage Current, V_{GS} = 20 V, V_{DS} = 0 V 100 nΑ I_{GSSF} Forward $V_{GS} = -20 \ V, V_{DS} = 0 \ V$ GSSR Gate-Body Leakage Current, nΑ Reverse On Characteristics (Note 2) ٧ $V_{GS(th)}$ Gate Threshold Voltage $V_{DS} = V_{GS}, I_{D} = 250 \mu A$ 1 mV/∘C Gate Threshold Voltage $I_D = 250 \, \mu A$, Referenced to 25°C -4.5 $\Delta V_{\text{GS(th)}}$ ΔTJ Temperature Coefficient $R_{\text{DS}(\text{o}\,\text{n})}$ Static Drain-Source $V_{GS} = 10 \text{ V}, I_{D} = 5 \text{ A}$ 0.044 0.050 Ω $V_{GS} = 10 \text{ V}, I_D = 5 \text{ A}, T_J = 125 \circ \text{C}$ 0.066 0.100 On-Resistance 0.066 0.080 $V_{GS} = 4.5 \text{ V}, I_D = 3.9 \text{ A}$ $I_{D(on)}$ On-State Drain Current $V_{GS} = 10 \text{ V}, V_{DS} = 5 \text{ V}$ 40 Α Forward Transconductance $V_{DS} = 15 V_{H} I_{D} = 5 A$ 8 s g_{FS} **Dynamic Characteristics** $C_{i\underline{s}\,\underline{s}}$ Input Capacitance $V_{DS} = 15 V_{V_{GS}} = 0 V_{V_{GS}}$ 525 pF f = 1.0 MHz $C_{\underline{\mathfrak{o}}\underline{s}\underline{s}}$ Output Capacitance 315 рF C_{rss} Reverse Transfer Capacitance 185 pF Switching Characteristics (Note 2) Turn-On Delay Time V_{DD} = 15 V, I_D = 1 A, R_L = 15 Ω 12 30 $t_{d(on)}$ ns $V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$ Turn-On Rise Time t_r 10 25 ns $t_{\underline{\text{d}(\text{off})}}$ Turn-Off Delay Time 25 50 ns Turn-Off Fall Time 10 50 $t_{\rm f}$ ns $t_{\rm rr}$ Drain-Source Reverse $I_F = 5 A$, di/dt = 100A/ μ s 160 nS Recovery Time Q_g Total Gate Charge $V_{DS} = 15 V, I_{D} = 5A,$ 17 35 nC V_{GS} = 10 V $\mathbf{Q}_{g\,s}$ Gate-Source Charge 1.5 nС Q_{gd} Gate-Drain Charge 3.7 nC **Drain-Source Diode Characteristics and Maximum Ratings** Maximum Continuous Drain-Source Diode Forward Current 1.7 Α V_{SD} Drain-Source Diode Forward $V_{GS} = 0 V, I_{S} = 1.7 A$ 0.78 1.2 Voltage

Notes:

R_{BJA} is the sum of the junction-to-case and case-to-ambient resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{BJC} is guaranteed by design while R_{BJA} is determined by the user's board design.





Distributor of Fairchild Semiconductor: Excellent Integrated System Limited

Datasheet of SI9936DY - MOSFET 2N-CH 30V 5A 8-SOIC

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PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
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